

Insulated Gate Bipolar Transistor (Ultrafast Speed IGBT), 100 A



| PRODUCT SUMMARY | | | | |
|-------------------------------|------------------------|--|--|--|
| V _{CES} | 600 V | | | |
| V _{CE(on)} (typical) | 1.92 V | | | |
| V_{GE} | 15 V | | | |
| I _C | 100 A | | | |
| Speed | 8 kHz to 30 kHz | | | |
| Package | SOT-227 | | | |
| Circuit | Single switch no diode | | | |

FEATURES

· Ultrafast: optimized for minimum saturation voltage and speed up to 30 kHz in hard switching, > 200 kHz in resonant mode



- Very low conduction and switching losses
- Fully isolate package (2500 V_{AC/RMS})
- Very low internal inductance (≤ 5 nH typical)
- Industry standard outline
- UL approved file E78996
- · Designed and qualified for industrial level
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Lower overall losses available at frequencies = 20 kHz
- Easy to assemble and parallel
- · Direct mounting to heatsink
- · Lower EMI, requires less snubbing
- Plug-in compatible with other SOT-227 packages

| ABSOLUTE MAXIMUM RATINGS | | | | | |
|--|-----------------------------------|--|-------------|-------------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MAX. | UNITS | |
| Collector to emitter breakdown voltage | V _{CES} | | 600 | V | |
| Continuous collector current | | T _C = 25 °C | 200 | | |
| Continuous collector current | I _C | T _C = 100 °C | 100 | | |
| Pulsed collector current | I _{CM} | | 400 | Α | |
| Clamped inductive load current | I _{LM} | V_{CC} = 80 % (V_{CES}), V_{GE} = 20 V, L = 10 μH, R_g = 2.0 Ω , see fig. 13a | 400 | | |
| Gate to emitter voltage | V_{GE} | | ± 20 | V | |
| Reverse voltage avalanche energy | E _{ARV} | Repetitive rating; pulse width limited by maximum junction temperature | 160 | mJ | |
| RMS isolation voltage | V_{ISOL} | Any terminal to case, t = 1 min | 2500 | V | |
| Maximum power dissipation | P _D | T _C = 25 °C | 500 | W | |
| | | T _C = 100 °C | 200 | | |
| Operating junction and storage temperature range | T _J , T _{Stg} | | -55 to +150 | °C | |
| Mounting torque | | 6-32 or M3 screw | 1.3 (12) | Nm (lbf.in) | |

| THERMAL AND MECHANICAL SPECIFICATIONS | | | | | | | |
|--|-----------------------------------|------------------------|------|------|------------|-------------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | |
| Junction and storage temperature range | T _J , T _{Stg} | | -55 | - | 150 | | |
| Thermal resistance, junction to case | R _{thJC} | R _{thJC} | | - | 0.25 | °C/W | |
| Thermal resistance case to heatsink | R _{thCS} | Flat, greased, surface | - | 0.05 | - |] | |
| Weight | | | | 30 | - | g | |
| Mounting torque | | Torque to terminal | - | - | 1.1 (9.7) | Nm (lbf.in) | |
| Mounting torque | | Torque to heatsink | - | - | 1.3 (11.5) | Nm (lbf.in) | |
| Case style | | SOT-227 | | | | | |



| ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified) | | | | | | | |
|--|----------------------------------|--|--|------|------|-------|-------|
| PARAMETER | SYMBOL | TEST CONDITION | MIN. | TYP. | MAX. | UNITS | |
| Collector to emitter breakdown voltage | V _{(BR)CES} | $V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$ | V _{GE} = 0 V, I _C = 250 μA | | - | - | |
| Emitter to collector breakdown voltage | V _{(BR)ECS} | $V_{GE} = 0 \text{ V}, I_{C} = 1.0 \text{ A}$ Pulse width $\leq 80 \mu\text{s}; \text{ duty factor } \leq 0.1 \%$ | | 18 | - | - | V |
| Temperature coefficient of breakdown voltage | $\Delta V_{(BR)CES}/\Delta T_J$ | V _{GE} = 0 V, I _C = 10 mA | | - | 0.38 | - | V/°C |
| Collector to emitter saturation voltage | V _{CE(on)} | I _C = 100 A | V _{GE} = 15 V See fig. 2, 5 | - | 1.60 | 1.9 | V |
| | | I _C = 200 A | | - | 1.92 | - | |
| | | I _C = 100 A, T _J = 150 °C | | - | 1.54 | - | |
| Gate threshold voltage | V _{GE(th)} | $V_{CE} = V_{GE}, I_{C} = 250 \mu A$ | | 3.0 | - | 6.0 | |
| Temperature coefficient of threshold voltage | $\Delta V_{GE(th)}/\Delta T_{J}$ | $V_{CE} = V_{GE}$, $I_C = 2.0 \text{ mA}$ | | - | -11 | - | mV/°C |
| Forward transconductance | 9 _{fe} | V_{CE} = 100 V, I_{C} = 100 A Pulse width 5.0 µs, single shot | | 79 | - | - | S |
| Zero gate voltage collector current | I _{CES} | $V_{GE} = 0 \text{ V}, V_{CE} = 600 \text{ V}$ | | - | - | 1.0 | mA |
| | | V _{GE} = 0 V, V _{CE} = 600 V, T _J = 150 °C | | - | - | 10 | 111/4 |
| Gate to emitter leakage current | I _{GES} | V _{GE} = ± 20 V | | - | = | ± 250 | nA |

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|---------------------------------|---------------------|--|------|--------|------|-------|
| Total gate charge (turn-on) | Qg | I _C = 100 A | - | 770 | 1200 | |
| Gate-emitter charge (turn-on) | Q_ge | V _{CC} = 400 V | - | 100 | 150 | nC |
| Gate-collector charge (turn-on) | Q_{gc} | V _{GE} = 15 V; See fig. 8 | - | 260 | 380 | |
| Turn-on delay time | t _{d(on)} | | - | 54 | - | ns ns |
| Rise time | t _r | $T_J = 25 ^{\circ}\text{C}$ $I_C = 100 \text{A}$ | - | 79 | - | |
| Turn-off delay time | t _{d(off)} | V _{CC} = 480 V | - | 130 | 200 | |
| Fall time | t _f | V _{GE} = 15 V | - | 300 | 450 | |
| Turn-on switching loss | E _{on} | $R_g = 2.0 \Omega$ | - | 0.98 | - | mJ |
| Turn-off switching loss | E _{off} | Energy losses include "tail" See fig. 9, 10, 14 | - | 3.48 | - | |
| Total switching loss | E _{ts} | | - | 4.46 | 7.6 | |
| Turn-on delay time | t _{d(on)} | $T_J=150~^{\circ}\text{C}$ $I_C=100~\text{A, V}_{CC}=480~\text{V}$ $V_{GE}=15~\text{V, R}_g=2.0~\Omega$ Energy losses include "tail" See fig. 10, 11, 14 | - | 56 | - | |
| Rise time | t _r | | - | 75 | - | |
| Turn-off delay time | t _{d(off)} | | - | 160 | - | ns |
| Fall time | t _f | | - | 460 | - | |
| Total switching loss | E _{ts} | | - | 7.24 | - | mJ |
| Internal emitter inductance | L _E | Measured 5 mm from package | - | 5.0 | - | nΗ |
| Input capacitance | C _{ies} | V _{GE} = 0 V V _{CC} = 30 V | - | 16 500 | - | |
| Output capacitance | Coes | | - | 1000 | - | pF |
| Reverse transfer capacitance | C _{res} | f = 1.0 MHz; See fig. 7 | - | 200 | - | |

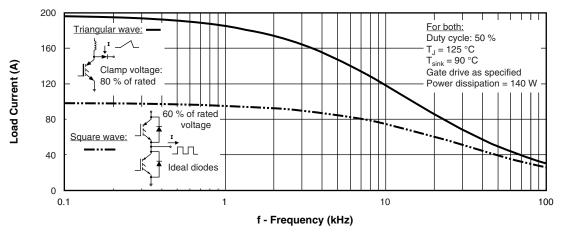


Fig. 1 - Typical Load Current vs. Frequency (Load Current = I_{RMS} of Fundamental)

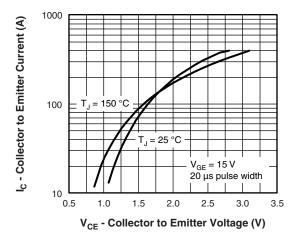


Fig. 2 - Typical Output Characteristics

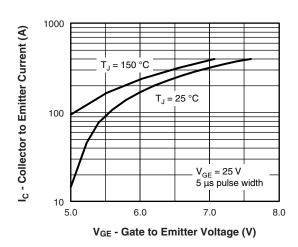


Fig. 3 - Typical Transfer Characteristics

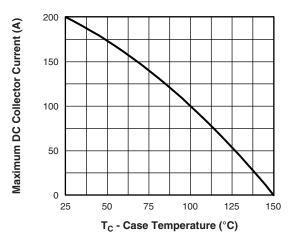


Fig. 4 - Maximum Collector Current vs. Case Temperature

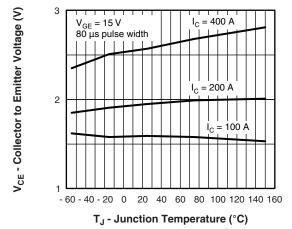


Fig. 5 - Typical Collector to Emitter Voltage vs. Junction Temperature



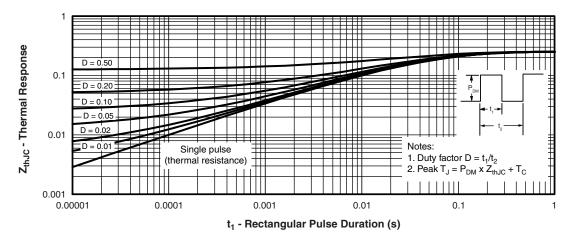


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction to Case

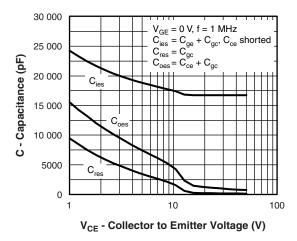


Fig. 7 - Typical Capacitance vs. Collector to Emitter Voltage

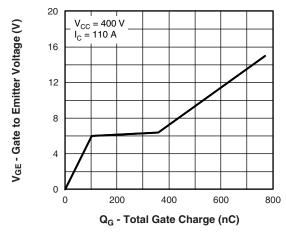


Fig. 8 - Typical Gate Charge vs. Gate to Emitter Voltage

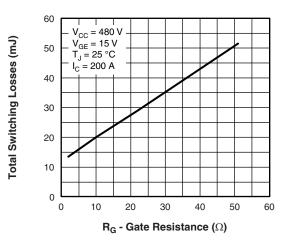


Fig. 9 - Typical Switching Losses vs. Gate Resistance

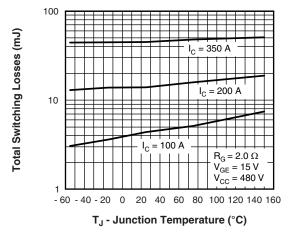


Fig. 10 - Typical Switching Losses vs. Junction Temperature



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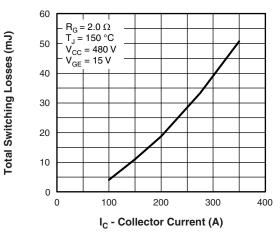


Fig. 11 - Typical Switching Losses vs. Collector Current

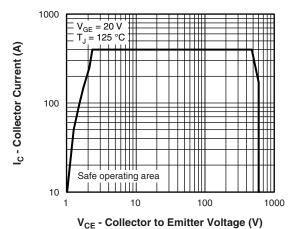
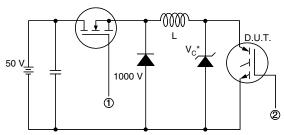


Fig. 12 - Turn-Off SOA



* Driver same type as D.U.T.; V_C = 80 % of V_{CE} (max)

Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain rated $\rm I_d$

Fig. 13a - Clamped Inductive Load Test Circuit

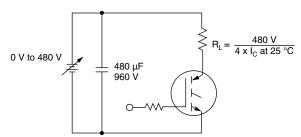


Fig. 13b - Pulsed Collector Current Test Circuit

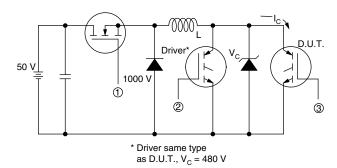


Fig. 14a - Switching Loss Test Circuit

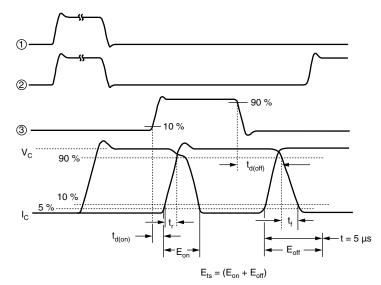
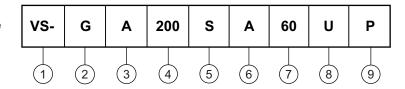


Fig. 14b - Switching Loss Waveforms



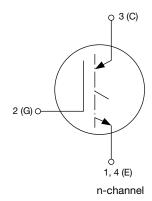
ORDERING INFORMATION TABLE

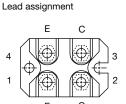
Device code



- 1 Vishay Semiconductors product
- Insulated Gate Bipolar Transistor (IGBT)
- 3 Generation 4, IGBT silicon, DBC construction
- Current rating (200 = 200 A)
- 5 Single switch, no diode
- 6 SOT-227
- 7 Voltage rating (60 = 600 V)
- Speed/type (U = ultrafast)
 - • None = standard production
 - P = lead (Pb)-free

CIRCUIT CONFIGURATION



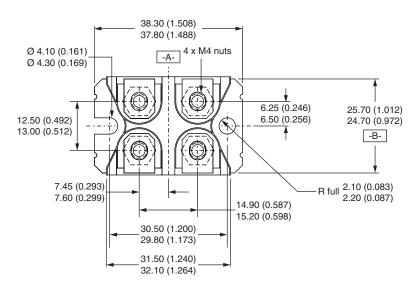


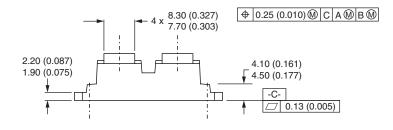
| LINKS TO RELATED DOCUMENTS | | | | |
|--|--------------------------|--|--|--|
| Dimensions <u>www.vishay.com/doc?95425</u> | | | | |
| Packaging information | www.vishay.com/doc?95423 | | | |

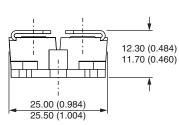


SOT-227 Generation II

DIMENSIONS in millimeters (inches)







Note

Controlling dimension: millimeter



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